

AMENDMENTS TO THE SPECIFICATION:

The present Amendment has been prepared in accordance with a revised format established by the U.S. Patent and Trademark Office, as permitted in the Pre-OG Notice entitled "Amendments in a Revised Format Now Permitted."

Please amend the title of the invention as follows:

~~--~~DRIVE CIRCUIT CONNECTION STRUCTURE
INCLUDING A SUBSTRATE, CIRCUIT BOARD, AND
SEMICONDUCTOR DEVICE, AND DISPLAY APPARATUS
INCLUDING THE CONNECTION STRUCTURE--.

Please *replace* the abstract of the disclosure with the following:

E! A circuit connection structure including a substrate, a circuit board, a semiconductor, and a flexible wiring member. The substrate has a part of a display panel and an electrode terminal formed thereon. The circuit board is disposed with a space between it and the substrate and has an electrode terminal. The semiconductor device bridges the space between the substrate and the circuit board and has a first electrode and a second electrode and includes a driver IC. The flexible wiring member has a conductor, of which, opposite ends are connected to the second electrode and the electrode terminal of the circuit board, respectively. The driver

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IC is connected to the substrate by connecting the first electrode to the electrode terminal on the substrate. By connecting the driver IC to the substrate in this manner, it becomes possible to obviate a conventional thermal problem of positional deviation.--
